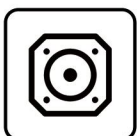


自主封測 品質把控 售後保障

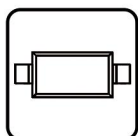
WEB | WWW.TDSEMIC.COM



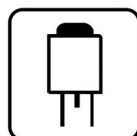
電源管理



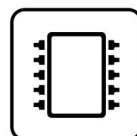
顯示驅動



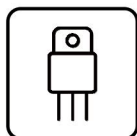
二三極管



LDO穩壓器



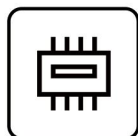
觸摸芯片



MOS管



運算放大器



存儲芯片



MCU



串口通信

SD03-TD

產品規格說明書

DESCRIPTION

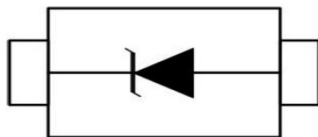
The SD03 designed for applications requiring transient overvoltage protection capability. They are intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment and other applications. These devices are ideal for situations where board space is at a premium.

This series has been specifically designed to protect sensitive components which are connected to power, data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (Cable Discharge Events), and EFT (electrical fast transients).

ORDERING INFORMATION

- ✧ Device: SD03
- ✧ Package: SOD-323
- ✧ Material: Halogen free and RoHS compliant
- ✧ Packing: Tape & Reel
- ✧ Quantity per reel: 3,000 pcs

PIN CONFIGURATION



FEATURES

- ✧ IEC61000-4-2 (ESD) $\pm 30\text{kV}$ (Contact)
 $\pm 30\text{kV}$ (Air)
- ✧ IEC61000-4-4 (EFT) 40A (5/50ns)
- ✧ 350 Watts Peak Pulse Power per (tp=8/20μs)
- ✧ Protects one I/O line (unidirectional)
- ✧ Low clamping voltage
- ✧ Working voltages: 3.3V to 36V
- ✧ Low leakage current

MACHANICAL DATA

- ✧ SOD-323 package
- ✧ Flammability Rating: UL 94V-0
- ✧ Packaging: Tape and Reel
- ✧ High temperature soldering guaranteed:
260°C/10s
- ✧ Reel size: 7 inch
- ✧ MSL 1

APPLICATIONS

- ✧ Cell Phone Handsets and Accessories
- ✧ Microprocessor based equipment
- ✧ Personal Digital Assistants (PDA's)
- ✧ Notebooks, Desktops, and Servers
- ✧ Portable Instrumentation
- ✧ Networking and Telecom
- ✧ Serial and Parallel Ports
- ✧ Peripherals

PACKAGE OUTLINE



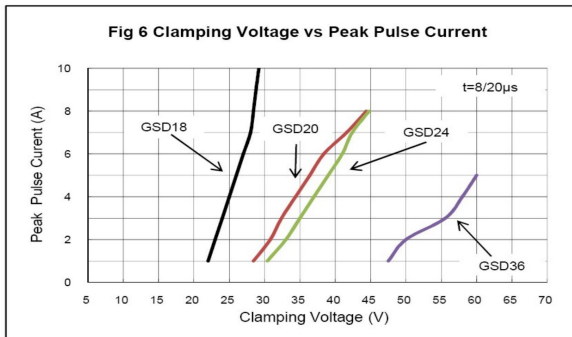
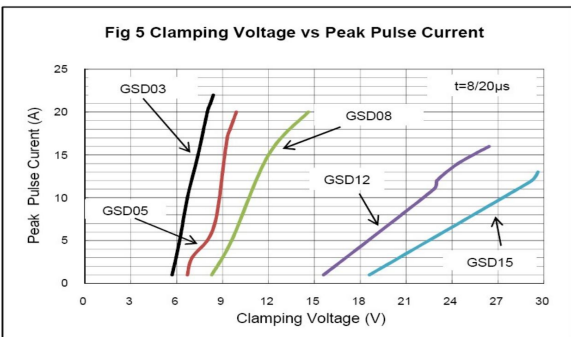
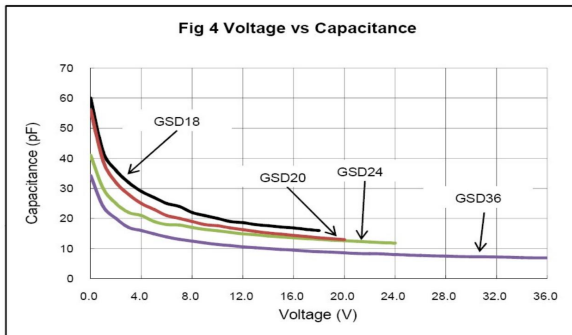
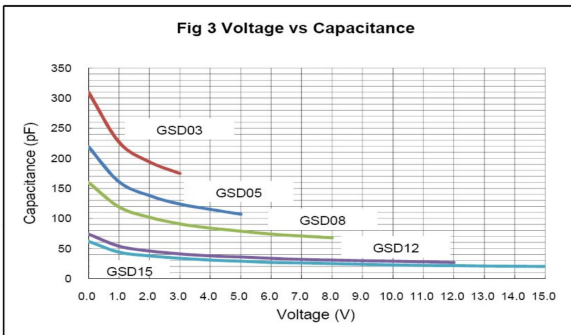
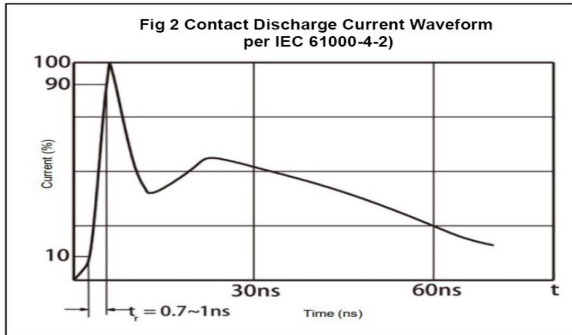
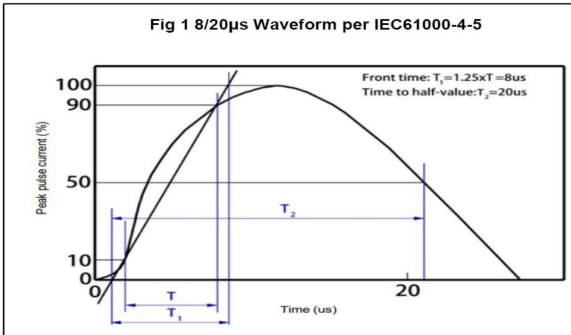
ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Units
V_{ESD}	ESD per IEC 61000-4-2 (Contact) ESD per IEC 61000-4-2 (Air)	± 30 ± 30	kV
P_{PP}	Peak Pulse Power (8/20 μ s)	350	W
T_{OPT}	Operating Temperature	-55/+150	°C
T_{STG}	Storage Temperature	-55/+150	°C
T_L	Lead Soldering Temperature	260 (10 sec.)	°C

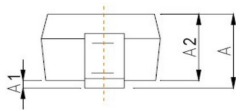
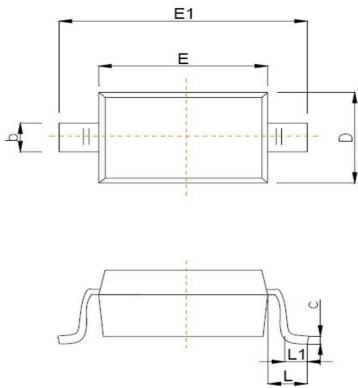
ELECTRICAL CHARACTERISTICS ($T_{amb}=25^{\circ}C$)

PART NUMBER	DEVICE MARKING	V_{RWM} (V) (max.)	V_B (V) (min.)	I_T (mA)	$V_{C@1A}$ (V) (max.)	V_C (V) (max.) (@A)		I_R (μ A) (max.)	C_T (pF) (max.)
SD03	03W	3.3	4	1	6.5	14	20	40	450
SD05	05W	5	6	1	9.8	18	17	10	300
SD08	08W	8	8.5	1	10.5	24	15	1	240
SD12	12W	12	13.3	1	19	32	11	1	130
SD15	15W	15	16.7	1	24	38	10	1	120
SD18	18W	18	20.0	1	29	45	9	1	100
SD20	20W	20	22.3	1	35	50	8	1	90
SD24	24W	24	26.7	1	43	52	7	1	80
SD36	36W	36	40	1	60	75	5	1	60

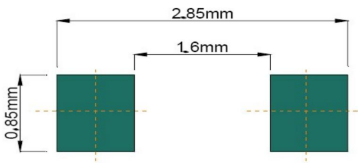
ELECTRICAL CHARACTERISTICS CURVE



SOD-323 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters	
	Min	Max
A		1.00
A1	0.000	0.100
A2	0.800	0.900
b	0.250	0.350
c	0.080	0.150
D	1.200	1.400
E	1.600	1.800
E1	2.500	2.700
e	1.800	2.040
L	0.475 REF	
L1	0.250	0.400
θ	0°	8°



Recommended Pad outline